APPLICATION FOR NEW COURSE

	Submitted by Colleg	e of Engineering		Date	11/22/05
	Department/Divisio	offering course Electri	ical and Computer Engine	ering	
2.	Proposed designation	n and Bulletin description	of this course		
	a. Prefix and Nu				Electromechanical Systems
		E: If the title is longer than 24 characters (including spaces), write sible title (not exceeding 24 characters) for use on transcripts			EMS/NEMS
	c. Lecture/Discu	sion hours per week	on hours per week 3 d. Laboratory hou		rs per week
	e. Studio hours p	er week	f.	Credits	3
	g. Course descri	tion			
	This course p	This course provides an overview of micromachined structures with an empasis on operational theory and			
	fabrication ted	hnology.			
	h. Prerequisites	•			
	Engineering S	tanding or consent of in	nstructor.		
	i. May be repea	ed to a maximum of			(if applicable)
4.	To be cross-listed a	ME/MSE 555	1 sittle	18-12-1/2 -	12/ 7 Kall 8/31/
		Prefix and Num	ber ^	Signature, Chairman, cr	oss-listing department
5.	Effective Date	Spring 2006 3 CIO	4 p pv	(semester and year)	Fruit 0 =/22/06
6.	Course to be offere	I [] F	Fall Spring	Summer	
7 .	Will the course be				Yes 🗖 No
	(Evalaia ifaat anns	~11)			
	(Explain if not ann	any)			
		ану)		· · · · · · · · · · · · · · · · · · ·	
8.	Why is this course	needed?			
8.	Why is this course	needed?	currently no existing cours	es that include these t	ypes of devices.
8.	Why is this course	needed?	currently no existing cours	es that include these t	ypes of devices.
8. 9.	Why is this course This course is nee	needed?	currently no existing cours	es that include these t	ypes of devices.
	Why is this course This course is nee a. By whom w b. Are facilitie	needed? ded because there are	Dr. Ingrid St. Omer	es that include these t	ypes of devices. Yes No

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10.	What enrollment may be reasonably anticipated?		
11.	Will this course serve students in the Department primarily?	☑ Yes	□ No
	Will it be of service to a significant number of students outside the Department? If so, explain.	☐ Yes	No No
	Design and manufacture of MEMS/NEMS structures requires an interdisciplinary approach.		
	Will the course serve as a University Studies Program course?	☐ Yes	☑ No
	If yes, under what Area?		
12.	Check the category most applicable to this course		
	traditional; offered in corresponding departments elsewhere;		
	relatively new, now being widely established		
	not yet to be found in many (or any) other universities		
13.	Is this course applicable to the requirements for at least one degree or certificate at the University of Kentucky?	✓ Yes	☐ No
14.	Is this course part of a proposed new program: If yes, which?	☐ Yes	✓ No
15.	Will adding this course change the degree requirements in one or more programs?* If yes, explain the change(s) below	☐ Yes	D∕ No
16.	Attach a list of the major teaching objectives of the proposed course and outline and/or reference list	to be used.	
17.	If the course is a 100-200 level course, please submit evidence (e.g., correspondence) that the Commbeen consulted.	unity College	System has
18.	If the course is 400G or 500 level, include syllabi or course statement showing differentiation for und students in assignments, grading criteria, and grading scales.	lergraduate an	nd graduate
19.	Within the Department, who should be contacted for further information about the proposed course?		
	Name Dr. Ingrid St. Omer Phone Extension	257-6143	

^{*}NOTE: Approval of this course will constitute approval of the program change unless other program modifications are proposed.

APPLICATION FOR NEW COURSE

Signatures of Approval:	
V. Cin	11/22/05
Department Chair 21-0 un Favor	Date
Suhard Drongard	12-01-09
Dean of the College	Date
	11-20-09
A	Date of Notice to the Faculty
, XXX	4-28-2010
*Undergraduate Council	Date
*University Studies	Date
*Graduate Council	Date
*Academic Council for the Medical Center	D-4-
Academic Council for the Medical Center	Date
*Senate Council (Chair)	Date of Notice to University Senate
*If applicable, as provided by the Rules of the University Senate	
confirmation we for the state of the state o	

EE/MSE/ME 555 Micro-/Nano- Electromechanical Devices

University of Kentucky

Department of Electrical & Computer Engineering

Fall 20XX

Tuesday, Thursday 9:30 – 10:45 am FPAT 263
3 credit hours

Instructor: Dr. Ingrid St. Omer

Office: 471 FPAT

Office hours: Mon. 1:30-3:30 pm,

Tues. 4:00-5:30 pm, or by appointment.

Phone: 257-6143

Email: istomer@engr.uky.edu

Course Grading Criteria

Homework	20 %
Midterm	25 %
Final Exam	30 %
Project	25 %
Total	100 %

Our accreditation association and policy of the Graduate School require that there be different assignments and grading criteria for undergraduate students and graduate students in 400G and 500-level courses. For this reason, you will find differences in course requirements and/or grading criteria in this class, posted on the syllabus. *In this course, the differentiation will be noted in the scope of the class project.*

Project

Undergraduate students will give a presentation to the class that summarizes a technical paper on a topic related to sensor design, fabrication, materials or device operation. Graduate students will give a presentation that analyzes a technical paper and related experimental precedent. Graduate students will also be expected to propose an appropriate method for future experimental work. The instructor will provide a list of suggested topics to the students. Students may also propose alternative topics to the instructor. Two pre-presentation meetings with the instructor are required. The first meeting will take place between weeks 6 and 8 of the term. The second meeting must be held at least one week before the scheduled presentation. At the second meeting an outline of the talk is due. Presentations will be scheduled during weeks 14 and 15 of the term. A written summary of the seminar project will be due within 7 days of the oral presentation for all students.

Final Grade:

Undergraduate	Graduate [©]
85 – 100 % (A)	85 – 100 % (A)
75 – 84 % (B)	75 – 84 % (B)
50 – 74 % (C)	50 – 74 % (C)
40 – 49 % (D)	Below 49% (E)
Below 40 % (E)	

Note: Graduate students must earn a C or better in the course to receive credit. A cumulative GPA of less that 3.0 can result in scholastic probation or dismissal depending on student status. Consult the Graduate School Bulletin for specific regulations.

Textbook

Marc J. Madou, Fundamentals of Microfabrication: The Science of Miniaturization, 2nd Ed., CRC Press, 2002.

References:

Gregory T.A. Kovacs, *Micromachined Transducers Sourcebook*, WCB/McGraw-Hill, 1998. Stephen Campbell, *The Science and Engineering of Microelectronic Fabrication*, Oxford University Press, 1996.

S. M. Sze, *Semiconductor Sensors*, John Wiley & Sons, Inc., 1994. Ljubisa Ristic, *Sensor Technology and Devices*, Artech House, 1994.

Prerequisites:

Engineering standing or consent of instructor.

Course Web Site:

A course homepage is available at http://courses.engr.uky.edu/ECE/ee555. The course site contains the above information, a tentative schedule, and it will be updated periodically to reflect homework assignments and solutions. The instructor reserves the right to change the schedule as needed. The web site also includes some links to various external sites that you may or may not find useful. An additional resource is the textbook website whose address is http://mmadou.eng.uci.edu/Edu_Services/MEMSEdu.htm.

Course Content

This course provides an overview of micromachined structures with an emphasis on operational theory and fabrication technology.

Topics

Sensor Classification and Terminology

Classification of Semiconductor Sensors

Sensor Parameters

Semiconductor Sensor Technologies

Basic Semiconductor Fabrication Processes

Materials Properties

Dimensional Effects

Bulk Micromachining

Surface Micromachining

LIGA and Micromolding

Modeling and Simulation

Packaging

Scaling and Nanotechnology

Sensor Examples

Mechanical

Optical

Thermal

Chemical/Biological

Microfluidic

Student Learning Outcomes

Upon completion of the course, the student should be able to:

- Define important terminology used in the discussion and design of MEMS/NEMS structures
- Discuss the classification scheme and give examples of each type of signal
- Discuss the design and fabrication cycle in terms of the modeling, simulation, fabrication, packaging, and manufacturing
- Explain the importance of materials, their physical properties, and influence, in the fabrication and operation of MEMS/NEMS structures
- Explain the fundamental processes for micromachining
- Determine the substrate and machining approach for a new micromachining application

Homework

Homework is due at the beginning of the indicated class period. Late homework will not be accepted.

Class Participation

During portions of the lecture students will work in small groups to practice problem-solving skills. Students are expected to work productively with their classmates on these tasks. In addition, students are expected to contribute to class discussions during the lectures.

Classroom Behavior, Decorum and Civility

Students and faculty are expected to treat everyone present in the classroom with respect and civility. Disparate treatment will not be tolerated. Disparate treatment occurs when one or more persons treat an individual less favorably on the basis of their actual or perceived race, sex, age, color, national origin, religion, disability, veteran status, and/or sexual orientation. All interactions should be characterized by respect for, and consideration of, others present in the classroom.

Cellular phones, pagers, and other electronic devices should be turned off prior to entering the classroom. Any cellular phone or pager that disrupts the classroom environment will be confiscated.

Attendance

Students are expected to be *on time* and to attend every class. **It should be noted that some of the material presented in class is not found in the textbook.** Therefore, consistent attendance is strongly recommended. If a student must miss class, the student is responsible for making up any work that was missed. As previously stated, assignments are due at the beginning of the class period and late homework will not be accepted.

The following are defined as acceptable reasons for excused absences:

- 1. serious illness:
- 2. illness or death of family member;
- 3. University-related trips;
- 4. major religious holidays.

If a student must be absent for one of these reasons, the student should notify the instructor as soon as possible but no later than the second absence. Appropriate documentation regarding the nature of the absence will be required. Students anticipating an absence for a major religious holiday are responsible for notifying the instructor in writing of anticipated absences.

Cheating and Plagiarism

Cheating - claiming another individual's work as your own or permitting another person to claim your work.

Plagiarism - claiming another person's work, writing or ideas as your own. *This includes material from the Internet or other digital media.*

You are encouraged to discuss the material in this course, including homework problems (and solutions and answers) with other students but you *cannot simply copy another student's homework paper and hand it in.* Working together is OK and encouraged. **Copying**, however, is cheating and both the student who copies and the student who provides the solution will be punished. On exams, the work must be totally your own unless explicitly stated otherwise.

Cheating and plagiarism will not be tolerated at this university. The <u>minimum</u> penalty is a failing grade in the course; the maximum penalty is expulsion from the university. If you have any questions, ask.

Classroom and Learning Accommodations

If you have a documented disability that requires academic accommodations, please see me as soon as possible during scheduled office hours. In order to receive accommodations in this course, you must provide me with a **Letter of Accommodation** from the Disability Resource Center (Room 2, Alumni Gym, 257-2754, <u>jkarnes@uky.edu</u>) for coordination of campus disability services available to students with disabilities.

TENTATIVE SCHEDULE

WEEK	DATE	TOPIC	READINGS
1	8/25	Introduction and Terminology	Madou, Roadmap
		Classification & Parameters	pp. 615-630
2	8/30	Lithography	Madou, pp. 1-31
	9/2		Madou pp. 31-70
3	9/5	Labor Day Holiday	11
	9/6	Dry Etching	Madou pp. 77-116
	9/8	, ,	
4	9/13	Additive Techniques	Madou pp. 123-154
	9/15		Madou pp. 154-174
5	9/20	Bulk Micromachining	Madou pp. 183-228
	9/22		Madou pp. 228-249
6	9/27	Surface Micromachining	Madou pp. 259-292
	9/29		
7	10/4	Materials issues	Madou pp. 293-313
	10/6		handouts
	10/8	Fall Break	
8	10/11	LIGA	Madou pp. 325-368
	10/13		Madou pp. 369-371
9	10/18	Review	
	10/20	MIDTERM	
10	10/25	Miniaturization & Manufacturing	Madou pp. 379-423
	10/27		Madou pp. 423-458
11	11/1	Modeling & Simulation	Madou pp. 467-523, Ristic Ch. 2
	11/3	Scaling Issues	Madou pp. 535-546
12	11/8	Actuators	Madou pp. 547- 579, handouts
	11/10	Fluidics	Madou pp. 579-587
13	11/15	Thermal, Chemical, etc.	Madou pp. 587-600
	11/17	Power	Madou pp. 600-605
14	11/22	Nanostructures	Handouts
	11/24	Thanksgiving Break	
15	11/29	Project Presentations	
	12/1	Project Presentations	
16	12/6	Project Presentations	
	12/8	Project Presentations	
17	12/16	FINAL EXAM: Friday, December 16,	
		8:00-10:00 am	